



Product Change Notification

Change Notification #: 114564 - 00
Change Title: Intel® Server Chassis P4304XXSHDR
PCN114564 - 00, Product Design, Label
Update the Front Panel Printed Circuit
Board and Power Button LED, Update
Regulatory and Safety Labels
Date of Publication: April 27, 2016

Key Characteristics of the Change:

Product Design, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *:	May 9, 2016
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Chassis P4304XXSHDR:

1. Update the Safety Label: Put an EAC logo instead of a GOST logo for certification update. Please see Figure-1 and Figure-2 below for details.



Figure-1: Pre-Change



Figure-2: Post-Change

- Update the packaging regulatory label, with New Australia/New Zealand (RCM) Logo and the Safety Nemko Logo. Please see Figure-3 and Figure-4 below for details.



Figure-3: Pre-Change



Figure-4: Post-change

- Update the regulatory label with New Australia/New Zealand (RCM) Logo and the Safety Nemko Logo. Please see Figure-5 and Figure-6 below for details.



Figure-5: Pre-Change



Figure-6: Post-Change

- Update the power button cap icon outer diameter from 4.0mm to 3.5mm. The transparent area on the post-change button is more centralized than on the pre-change one. The purpose of this change is to make the button brighter. The post change button icon is smaller, but more of the icon area is directly illuminated by the LED. See the Figure-7 for details.



Figure-7: Power Button Cap change

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
P4304XXSHDR	916171	G51303-002	G51303-003

PCN Revision History:**Date of Revision:**

April 27, 2016

Revision Number:

00

Reason:

Originally Published PCN



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114564 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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